As a new student, tuition numbers can be scary. But with a wide array of scholarship and financial aid opportunities available at UH, college can truly become affordable.

The University of Houston and the Cullen College of Engineering offer many scholarship opportunities, and encourage you to also explore outside scholarship options on websites like FastWeb (www.fastweb.com), StudentScholarships.org, Collegeboard (www.collegeboard.org), Hispanic College Fund (hsf.net/en/scholarships), The National Data Base Scholarships (www.free-4u.com) and US College Scholarships and Grants (www.scholarshipsandgrants.us).

Learn more and apply for scholarships at www.uh.edu/financial/undergraduate/types-aid/scholarships.

Students can also compete for the Tier One Scholarship. The deadline to apply is November 15, 2017: http://www.uh.edu/tieronescholars/eligibility/Application/

Learn more about Tier One Scholars at http://www.uh.edu/tieronescholars/ and the Tier One Scholarship: http://www.uh.edu/tieronescholars/eligibility/FAQ/

After two semesters of classes at UH, Cullen College students may apply for college-specific scholarships from the Dean's Office. These scholarships are competitive and generally require a cumulative and major GPA of 3.0. In addition, several endowments support scholarship awards for currently enrolled Cullen College students annually.

### Engineering Undergraduate Scholarship Application

This scholarship application is open to current Cullen College of Engineering undergraduate students. The scholarships available through the Cullen College of Engineering Dean's Office are competitive and in general require:

- UH Cumulative GPA: 3.0
- UH Major GPA: 3.0

**Additional criteria:**

- Successful completion of ENGI 1100, ENGI 1331, and one of the following courses that is required on your major degree plan:
  - BIOE 2331
  - CHEE 2331
  - CIVE 2330
  - ECE 2201
  - INDE 2333
You will only be allowed to complete one (1) application as it is sufficient to be considered for all Dean’s Office Undergraduate Scholarships. It is recommended to complete this application on the computer and not a phone or tablet to avoid mistakes.

If there is a problem with your application, please email bgreen3 [at] central [dot] uh [dot] edu (Brandon Green) or sewillie6 [at] central [dot] uh [dot] edu (Sarah Williamson).

Several endowments support scholarship awards for currently enrolled Cullen College of Engineering students, including:

- Roy and Lillie Cullen Scholarship
- Houston Chapter American Petroleum Institute Scholarship*
- Leonard A. Porter Memorial Scholarship
- L. Douglas and Jeannette C. Power Endowment
- Bill and Gail McNeese Scholarship Endowment
- Thomas J. and Vera A. Stufflebeam Endowment
- Prem & Gaynelle Dewan Scholarship Endowment
- Chevron Scholarship Endowment*
- The Robert W. Baldwin Pi Kappa Alpha Scholarship Endowment
- C. V. Kirkpatrick Engineering Scholarship Endowment
- Houston Chapter Gas Processors Association Scholarship
- Ronald and Bertha Lohec Scholarship Endowment Fund
- Margie Nell Eaves Seiver Scholarship Endowment
- The Baker Hughes Engineering Excellence Scholarship Endowment

Only one application is needed to apply for all Dean's Office scholarships.

**Application Deadline:** Applications may be filed March 1, 2017 – May 31, 2017

Recommendations for awards are typically given by July 15th, before the priority deadline required by the Office of Scholarships and Financial Aid. If a scholarship is awarded, it will be posted to the myUH account and can be checked looking under the Student Financials section.

NOTE: Not all of the Engineering Undergraduate Scholarships qualify for a tuition waiver.

**TcsUH Scholarships**

The Texas Center for Superconductivity (TcsUH) offers the following scholarship to undergraduate and graduate students each year:

- TcsUH Cora Hawley Scholarships [12]

**Other Scholarships**

- Chemical and Biomolecular Engineering [13]
- Civil & Environmental Engineering [14]
- Electrical and Computer Engineering [15]
- Industrial Engineering [16]
- Mechanical Engineering [17]